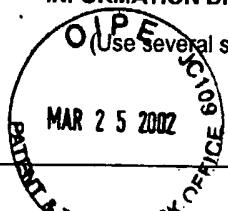


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HV	4,722,906	2/1988	Guire			
	4,826,759	5/1989	Guire et al			
	4,973,493	11/1990	Guire			
	4,979,959	12/1990	Guire			
	5,002,582	3/1991	Guire et al			
	5,073,484	12/1991	Guire et al			
	5,217,492	6/1993	Guire et al			
	5,258,041	11/1993	Guire et al			
	5,263,992	11/1993	Guire			
	5,414,075	5/1995	Swan et al.			
HV	5,512,329	4/1996	Guire et al			

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						YES	NO
HV	PCT/US85/01852	4/1986	PCT				
	PCT/US87/01018	11/1987	PCT				
	PCT/US87/02675	4/1988	PCT				
	PCT/US88/04487	2/1990	PCT				
HV	PCT/US88/04491	6/1989	PCT				

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HV	"Radical Polymerization," C.H. Bamford, pp. 940-957 in Kroschwitz, ed., <i>Concise Encyclopedia of Polymer Science and Engineering</i> , 1990
HV	"Plastics," pp. 462-464, in <i>Concise Encyclopedia of Polymer Science and Engineering</i> , Kroschwitz, ed., John Wiley and Sons, 1990

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HV	5,512,474	4/1996	Clapper et al.			
	5,563,056	10/1996	Swan et al.			
	5,637,460	6/1997	Swan et al.			
	5,714,360	2/1998	Swan et al.			
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HV	6,020,147	2/2000	Guire			

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		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
HV		PCT/US89/02914	1/1990	PCT				
HV		PCT/US90/05028	4/1991	PCT				
		PCT/US90/06554	5/1991	PCT				
		PCT/US93/01248	8/1993	PCT				
HV		PCT/US93/10523	5/1994	PCT				

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HV	6,077,698	12/1999	Swan et al.			
	6,090,995	7/2000	Reich et al.			
	6,096,369	8/2000	Anders et al.			
	6,121,027	9/2000	Clapper et al.			
	6,156,345	12/2000	Chudzik et al.			
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HV	6,245,089	6/2001	Daniel et al.			

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		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
HV		PCT/US94/12659	5/1995	PCT				
		PCT/US96/07695	11/1996	PCT				
		PCT/US96/08797	12/1996	PCT				
		PCT/US96/17645	5/1997	PCT				
HV		PCT/US97/05344	9/1997	PCT				

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		APPLICANT Chappa et al					
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	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
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	PCT/US01/40255	9/2001	PCT				
	WO 99/15917	4/1999	PCT				
	WO 01/17575	3/2001	PCT				
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Hv		6,221,425	4/2001	Michal et al.	427	2.25	APR 24 2001
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